Document Number: XTAH25060A2C Preliminary Datasheet V1.0

GaN HEMT 28V, 2450MHz 60W, RF Power Transistor Description

The XTAH25060A2C is a 60W GaN HEMT, designed for ISM/RF Energy application at 2.45GHz It can be used in CW, Pulse and any other modulation modes. There is no guarantee of performance when this part is used in applications designed outside of these frequencies.

 Typical 2.4-2.5GHz full band class AB RF Performance with device soldered Vds=28V, Vgs=-3V

Voltage(V)	Pin(dBm)	Psat(W)	Gain(dB)	Eff(%)
28	33	63-66	15~15.2	74-76
32	33	77-81	15.9~16.1	72-73

Recommended driver: ITEH40004P3 or GTAH80004PD

Applications

- S band power amplifier
- ISM/RF Energy power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

- 1. Set VGS to the pinch--off (VP) voltage, typically –5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

- Turning the device OFF
- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+150	Vdc
GateSource Voltage	V_{GS}	-8 to +0.5	Vdc
Operating Voltage	V _{DD}	36	Vdc
Maximum gate current	lgs	18	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	٥°
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Baio	3.2	°C /M
T _c = 85°C, at Pdiss=25W	Rejc	3.2	°C /W

Table 3. Electrical Characteristics (TA = 25° unless otherwise noted)

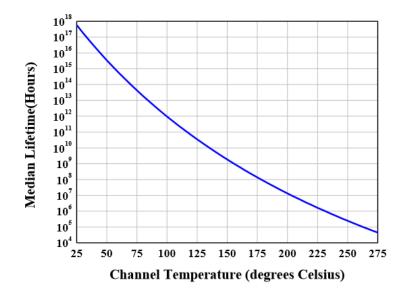
DC Characteristics (measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=13.6mA	V _{DSS}		150		V
Gate Threshold Voltage	VDS =10V, ID = 13.6mA V _{GS(th)} -4			-2	V	
Gate Quiescent Voltage	VDS =28V, IDS=200mA, Measured in Functional Test	V _{GS(Q)}		-2.27		V



Ruggedness Characteristics						
Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.5GHz, Pout=60W Pulsed CW					
	All phase,	VSWR		10:1		
	No device damages					

Figure 2: Median Lifetime vs. Channel Temperature



Typical performance

Figure 5: Network analyzer output S11/S21

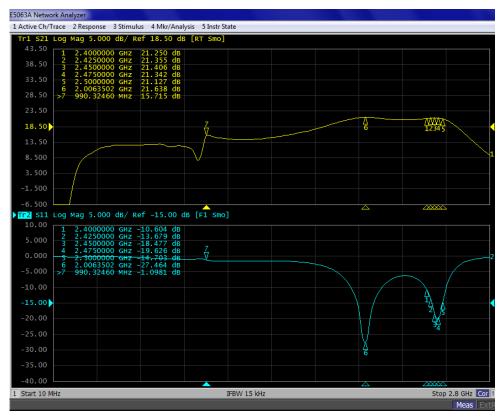


Figure 5: Picture of application board

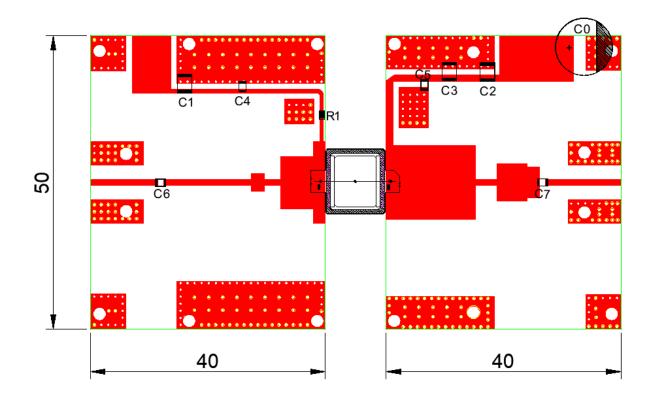
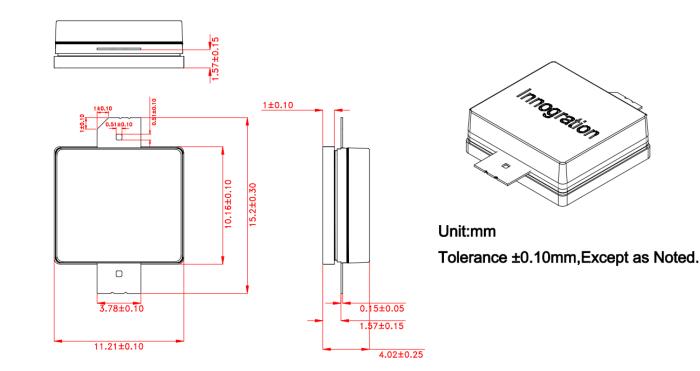


Table 4. Bill of materials of application board (PCB layout upon request)

Component	Description	Suggestion
СО	470uF/63V	Electrolytic Capacitor
C1, C2, C3	10uF	1210
C4, C5, C7	15pF	Beijing YuanLu HongYuan Electronic Technology CO., LTD MQ400805
C6	3.9pF	Beijing YuanLu HongYuan Electronic Technology CO., LTD MQ400805
R1	Chip Resistor,10Ω	0805
РСВ	Rogers 4350b, thickness 20 mils, 1oz copper	

Package Dimensions (Unit:mm)



Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status	
2025/1/23	V1.0	Preliminary Datasheet Creation	

Application data based on: RXT-25-01

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